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November 26, 2003

22388 U.S.PTO
10/7/21382
112603

MAIL STOP PATENT APPLICATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Re: Application of Hien Boon TAN and Anthony Yi Sheng SUN
HIGH DENSITY CHIP SCALE LEADFRAME PACKAGE AND METHOD OF
MANUFACTURING THE PACKAGE
Assignee: UNITED TEST AND ASSEMBLY TEST CENTER LTD.
Our Ref. Q78432

Dear Sir:

Attached hereto is the application identified above comprising thirty five (35) sheets of the specification, including the claims and abstract, ten (10) sheets of drawings, a copy of an executed Assignment and PTO 1595 form, and a copy of an executed Declaration and Power of Attorney.

The Government filing fee is calculated as follows:

Total claims	26	-	20	=	6	x	\$18.00	=	\$108.00
Independent claims	7	-	3	=	4	x	\$86.00	=	\$344.00
Base Fee									\$770.00

TOTAL FILING FEE	\$1222.00
Recordation of Assignment	\$40.00
TOTAL FEE	<u>\$1262.00</u>

Checks for the statutory filing fee of \$1222.00 and Assignment recordation fee of \$40.00 are attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this transmittal letter is attached.



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Benefit is claimed from:

<u>Country</u>	<u>Application No</u>	<u>Filing Date</u>
U.S. Provisional	60/429,315	November 27, 2002

Respectfully submitted,
SUGHRUE MION, PLLC

Attorneys for Applicant

By: The signature of Alan J. Kasper, written in cursive ink.

Alan J. Kasper
Registration No. 25,426

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CUSTOMER NUMBER

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